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IMPORTANT DATES

Abstract Submission Due: April 1, 2007
Acceptance Notice: June 1, 2007
Registration and Paper Submission Due: August 1, 2007

An Official Meeting of
Asian Pacific Association for Biomechanics (APAB)

Third Asian Pacific Conference on Biomechanics

November 5 - 8, 2007
Tokyo, Japan

FIRST CALL FOR PAPERS



Organized by:

Bioengineering Division, the Japan Society of
Mechanical Engineers (JSME)

Supported in part by:

Institute of Industrial Science, the University of Tokyo



PURPOSE

Asian Pacific Conference on Biomechanics (AP Biomech) has acted as a core forum for active scientists and engineers as well as young researchers from the Asian Pacific region since 2004. AP Biomech 2007 will be held to present and discuss the latest research, ideas, development and applications in the field of biomechanics. AP Biomech aims at promoting the collaboration of biomechanics societies/communities in the Asian Pacific region as an official meeting of Asian Pacific Association for Biomechanics.

TOPICS

Topics for free communications are listed below. In addition, the conference includes several plenary, keynote, and tutorial lectures.

1. Artificial Organs & Implants
2. Biorheology & Microcirculation
3. Bone & Ligament
4. Cardiopulmonary & Respiratory Mechanics
5. Cardiovascular Mechanics
6. Cellular & Tissue Engineering & Biomaterials
7. Dental Biomechanics
8. Micro & Nano Biomechanics
9. Musculo-Skeletal Biomechanics
10. Orthopaedic & Rehabilitation Biomechanics
11. Sensory Organ Mechanics
12. Sports & Impact Biomechanics
13. Others

SUBMISSION OF PAPERS

Authors must submit short abstracts for application to AP Biomech 2007. Accepted authors must submit short papers of one page after review. Full instructions on submission and abstract format will be found on the conference website.

SCIENTIFIC PROGRAM

Scientific program will consist of contributed papers presented in podium and poster sessions. The acceptance will be made after the review of submitted abstracts.

Conference Outline (tentative)

	Nov. 5 (Mon.)	Nov. 6 (Tue.)	Nov. 7 (Wed.)	Nov. 8 (Thur.)
Morning		Opening Plenary	Tutorial	Tutorial
Late Morning		Podium	Podium	Podium
Afternoon		Podium / Poster	Excursion	Podium
Late Afternoon	Registration	Podium		Closing
Evening	Get together		Banquet	

PUBLICATION

The short paper proceedings will be distributed at the conference. Authors of selected short papers are encouraged to submit full papers to *Journal of Biomechanical Science and Engineering* after further peer review.

LANGUAGE

Official language of the conference is English.

YOUNG PARTICIPANT SUPPORT

A dozen of doctoral/post doctoral participants will be financially supported in part.

CONFERENCE AWARD

Conference awards will be presented to excellent papers and presentations.

REGISTRATION

The full registration fee is expected to be 35,000 Japanese Yen (JPY), which covers a copy of the proceedings, get-together party, coffee break, daily lunch, the excursion and the banquet. The fee for students is planned to be 15,000 JPY excluding the banquet. The final plan will be announced in the 2nd circular and on the website.

ACCOMMODATION

Rooms are available in all hotel categories close to the conference site. Official agents will be authorized for participants' hotel bookings. Further information on accommodation will be announced in the 2nd circular and on the website.

CONFERENCE VENUE

The conference will be held at Komaba Convention Hall of the Institute of Industrial Science on the Komaba Research Campus of the University of Tokyo, Tokyo, Japan. Access to the conference venue will be found at

<http://www.iis.u-tokyo.ac.jp/english/map/index.html>

CONFERENCE WEBSITE

Conference website will be available soon at

<http://apb07.iis.u-tokyo.ac.jp/>

for up-to-date information.

CONFERENCE OFFICE

Secretariat-AP Biomech 2007

c/o Oshima Lab.

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